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Background

A.J. Incorvaia joined Siemens Digital Industries Software from Mentor Graphics, where he served since 2014 as vice president and general manager of the Board Systems Division. Prior to this, he was vice president of the PCB and IC Packaging Group at Cadence Design Systems. Other responsibilities during his sixteen years at Cadence included vice president of Product Development and engineering group director. Prior to Cadence, Incorvaia held software development and management positions at Viewlogic and Digital Equipment Corporation. He holds a B.S. in Computer Science from Rochester Institute of Technology, and an M.S. in Computer Science and Software Engineering from George Mason University.

About Siemens Digital Industries Software

Siemens Digital Industries Software helps organizations of all sizes digitally transform using software, hardware and services from the Siemens Xcelerator business platform. Siemens' software and the comprehensive digital twin enable companies to optimize their design, engineering and manufacturing processes to turn today's ideas into the sustainable products of the future. From chips to entire systems, from product to process, across all industries.